

S25HS02GTFABHV150

Parametrics	S25HS02GTFABHV150
Density	2048 MBit
Family	HS-T
Interface Bandwidth	102 MByte/s
Interface Frequency (SDR/DDR) (MHz)	166 / 102
Interfaces	Quad SPI
Lead Ball Finish	Sn/Ag/Cu
Operating Temperature min max	-40 °C 105 °C
Operating Voltage min max	1.8 V 1.7 V 2 V
Peak Reflow Temp	260 °C
Qualification	Industrial

Sales Product Name	S25HS02GTFABHV150
OPN Info	S25HS02GTFABHV150
Product Status	active and preferred
Infineon Package name	PG-BGA-24
Standard Package name	FBGA-24 (002-24801)
Completely lead free	yes
Halogen free	yes
RoHS compliant	yes
Packing Size	520

Sales Product Name	S25HS02GTFABHV150
Packing Type	TRAY
Moisture Level	3
Moisture Packing	DRY